

WEST Search History

DATE: Monday, August 25, 2003

Set Name Query
side by side

Hit Count Set Name
result set

DB=USPT,PGPB,JPAB,EPAB,DWPI,TDBD; PLUR=YES; OP=ADJ

L7	l6 and (solder or soldering or bump or ball or sphere or preform) near (height or tall or high or diameter or size)	12	L7
L6	l2 and (solder or soldering) near (bump or ball or sphere or preform)	33	L6
L5	l1 and (epoxy or polymer or resin or adhesive or solder) near (layer or film)	34	L5
L4	l1 and (epoxy or polymer or resin or adhesive or solder) near film	0	L4
L3	l1 and (conductive or conducting) near (epoxy or polymer or resin or adhesive)	24	L3
L2	L1 and (solder or soldered or soldering)	85	L2
L1	suspension and head and (metal or contact) near pad and slider	256	L1

END OF SEARCH HISTORY